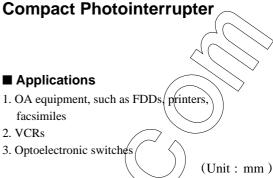
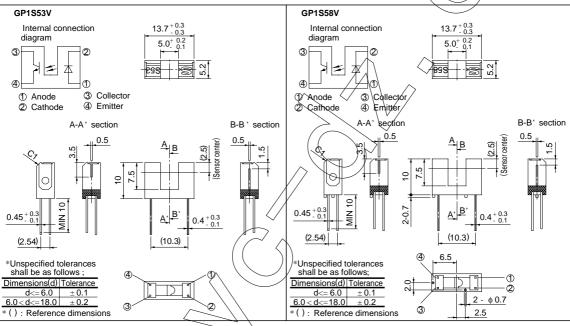
GP1S53V/GP1S58V

■ Features

- 1. Compact type
- 2. High sensing accuracy (Slit width: 0.5mm)
- 3. PWB direct mounting type
- 4. With positioning pin (**GP1S58V**)

■ Outline Dimensions





■ Absolute Maximum Ratings

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	*1Peak forward current	I _{FM}	<u>\1</u>	A
	Reverse voltage	V _R	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	VCEO	35	V
	Emitter-collector voltage	VECO	6	V
	Collector current	Ic	20	mA
	Collector power dissipation	Pc	75	mW
	Operating temperature	T _{opr}	- 25 to + 85	°C
Storage temperature		T _{stg}	- 40 to + 100	°C
*2 Soldering temperature		Tsol	260	°C

^{*1} Pulse width 100 µs, Duty ratio= 0.01

^{*2} For 5 seconds

■ Electro-optical Characteristics

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		V _F	$I_F = 20 \text{mA}$	-	1.25	1(4	V
	Peak forward voltage		V _{FM}	$I_{FM} = 0.5A$	-	3	4	V
	Reverse current		I_R	$V_R = 3V$	-		10	μ A
Output	Collector dark current		I_{CEO}	$V_{CE} = 20V$	-	(1(100	nA
Transfer characteristics	Collector Current		Ic	$I_F = 20mA$, $V_{CE} = 5V$	0.5	1-/	1,5/	mA
	Collector-emitter saturation	voltage	V _{CE(sat)}	$I_F = 40mA, I_C = 0.2mA$		- -	0.4	V
	Response time	Rise time	$t_{\rm r}$	$V_{CE} = 2V$, $I_{C} = 2mA$	1	3/	15	μs
		Fall time	t_{f}	$R_L\!=100\Omega$	- (4)	20	μs

Fig. 1 Forward Current vs. Ambient Temperature

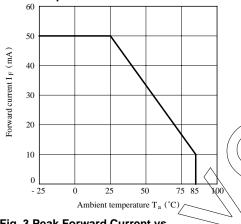


Fig. 3 Peak Forward Current vs. Duty Ratio

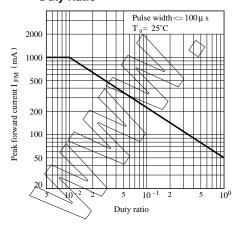


Fig. 2 Collector Power Dissipation vs.

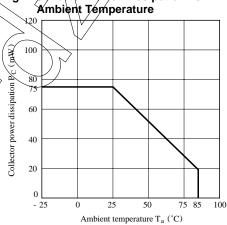


Fig. 4 Forward Current vs. Forward Voltage

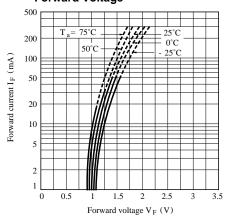


Fig. 5 Collector Current vs. Forward Current

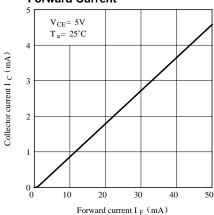


Fig. 7 Collector Current vs.
Ambient Temperature

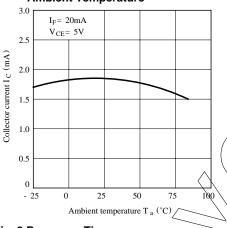


Fig. 9 Response Time vs. Load Resistance

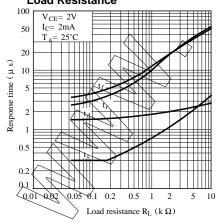


Fig.6 Collector Current vs.

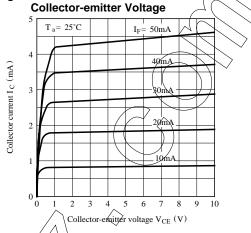
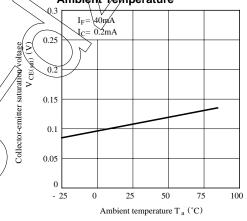
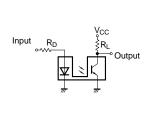
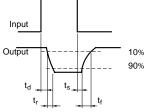


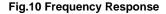
Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature



Test Circuit for Response Time







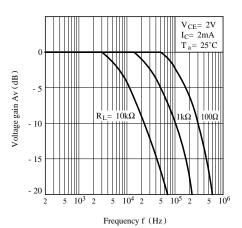


Fig.12 Relative Collector Current vs. Shield Distance (1)

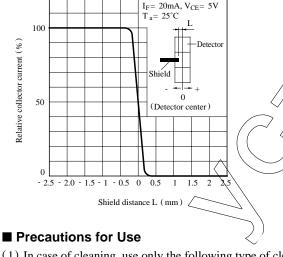


Fig.11 Collector Dark Current vs.

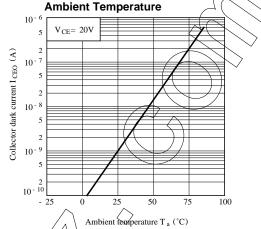
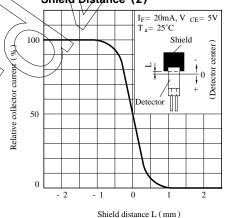
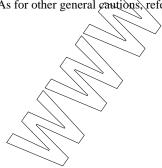


Fig.13 Relative Collector Current vs. Shield Distance (2)



(1) In case of cleaning, use only the following type of cleaning solvent. Ethyl alcohol, methyl alcohol, Isopropyl alcohol

(2) As for other general cautions, refer to the chapter "Precautions for Use".



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